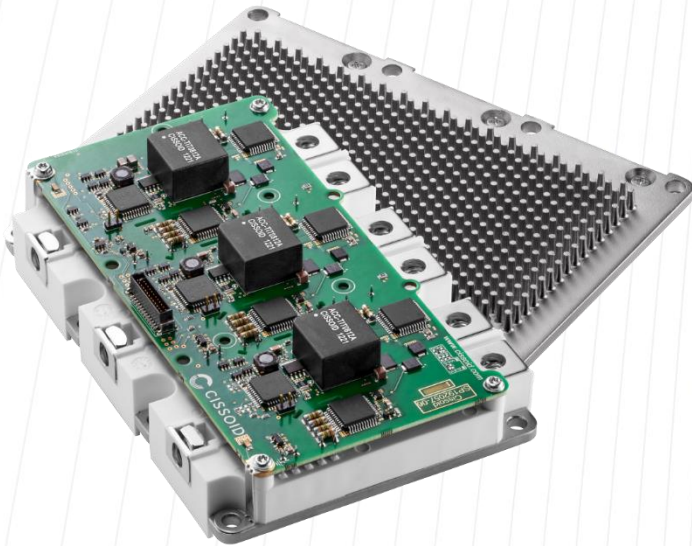


# Silicon Carbide Intelligent Power Module



Our 3-phase 1200V Silicon Carbide (SiC) MOSFET Intelligent Power Module platform integrates high-performance power switches and gate drivers, built on the CISSOID HADES2® chipset. Designed for high power density applications, these modules enable efficient operation at junction temperatures up to 175°C, fully leveraging the benefits of SiC technology—namely, low switching losses and high thermal resilience.

By integrating gate drivers within the power module, the solution delivers a fully validated and optimized design for fast switching, minimal losses, and high robustness against  $di/dt$  and  $dV/dt$  stress. It also ensures comprehensive protection of the power stage, including features like desaturation detection, undervoltage lockout (UVLO), active Miller clamping (AMC), soft shutdown (SSD), and anti-overlap control.

## ORDERING INFORMATION

Reference	Description
CXT-PLA3SA12340AAA	1200V / 340A control module, pin fin
CXT-PLA3SA12450AAA	1200V / 450A control module, pin fin
CXT-PLA3SA12550AAA	1200V / 550A control module, pin fin
CMT-PLA3SB12340AAA	1200V / 340A control module, flat baseplate



# CISSOID

POWER SEMICONDUCTORS

## POWER MODULE

- MAX DRAIN-TO-SOURCE VOLTAGE: 1200V
- MAX DC CURRENT: 340A-550A @  $T_C=25^\circ\text{C}$
- LOW ON RESISTANCE: 2.53MOHMS TO 4.19MOHMS
- LOW PARASITIC CAPACITANCE: TYP 11PF PER PHASE (PRIMARY-SECONDARY)
- ISOLATION: 3600VAC @50Hz (1MIN) (BASEPLATE - POWER PINS)
- COMMON MODE TRANSIENT IMMUNITY: >50kV/MS
- SWITCHING ENERGY@ 600V/300A:  $E_{ON}=7.5\text{MJ TO } 9\text{MJ}/E_{OFF}=7\text{MJ TO } 7.4\text{MJ}$
- SWITCHING FREQUENCY: 50KHZ MAX
- HIGH TEMPERATURE GATE DRIVER BOARD ( $125^\circ\text{C } T_A$ )
- MAX OPERATING JUNCTION TEMPERATURE ( $175^\circ\text{C } T_J$ )
- LIGHTWEIGHT ALSIC PIN-FIN OR FLAT BASEPLATE

## GATE DRIVER PROTECTIONS

- UNDER VOLTAGE LOCKOUT (UVLO)
- DESATURATION PROTECTION
- SOFT SHUTDOWN TURN-OFF (SSD)
- NEGATIVE GATE DRIVE (-3V)
- ACTIVE MILLER CLAMPING (AMC)
- GATE-SOURCE SHORT-CIRCUIT PROTECTION

## QUALIFICATION

- COMPLETE INTELLIGENT POWER MODULE ASSEMBLY QUALIFIED ACCORDING TO **AUTOMOTIVE AQC-324**



[WWW.CISSOID.COM](http://WWW.CISSOID.COM)





# Silicon Carbide Intelligent Power Module

IPM characteristics	CMT-PLA3SB12340	CXT-PLA3SA12340	CXT-PLA3SA12450	CXT-PLA3SA12550	Units
<b>V<sub>DS</sub> Breakdown Voltage</b>	1200				V <sub>DC</sub>
<b>R<sub>DS_ON</sub> (typical)</b>	3.25	4.19	3.25	2.53	mW
<b>Max Continuous Current (typical @ Tc=25°C)</b>	340	340	450	550	A <sub>RMS</sub>
<b>Maximum Continuous Current (typical @ Tc=90°C)</b>	295	260	350	450	A <sub>RMS</sub>
<b>Pulsed Drain Current</b>	720	720	720	720	A
<b>Short Circuit Resistance</b>	>2	>2	>2	>2	μs
<b>Thermal Resistance (J2C)</b>	0.183	0.167	0.130	0.106	°C/W
<b>Switching Energy Eon @600V/300A</b>	8.42	7.48	8.42	9	mJ
<b>Switching Energy Eoff @600V/300A</b>	7.05	7.39	7.05	7	mJ
<b>Turn-On/Off Delay (typ)</b>	180				ns
<b>Output Frequency</b>	DC to 2000				Hz
<b>Inverter PWM frequency</b>	< 50				kHz
<b>Isolation (1min)</b>	3000				V <sub>DC</sub>
<b>Common Mode Transient Immunity</b>	>50				kV/μs
<b>Operating Temperature</b>	-40 to +125				°C
<b>Weight</b>	550	590	590	590	g
<b>Dimensions (W – L – H)</b>	104 x 154 x 34	104 x 154 x 34	104 x 154 x 34	104 x 154 x 34	mm
<b>Heatsink</b>	Flat baseplate	Pinfin baseplate	Pinfin baseplate	Pinfin baseplate	
<b>Peak Efficiency</b>	>99				%